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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Etsuko NAKAMURA et al.

Serial No. 10/721,164

Filed November 26, 2003

LOWER LAYER MATERIAL FOR WIRING,
EMBEDDED MATERIAL, AND WIRING
FORMATION METHOD

:

: **Confirmation No. 5528**

: **Mail Stop: OFFICE OF INITIAL
PATENT EXAMINATION'S FILING
RECEIPT CORRECTIONS**

: Attorney Docket No. 2003_1698A

REQUEST FOR CORRECTED FILING RECEIPT

Commissioner for Patents
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Sir:

A corrected filing receipt is requested in the above-referenced case. A copy of the original filing receipt is enclosed, with the changes noted thereon.

Expedited issuance of the corrected filing receipt is respectfully requested.

Respectfully submitted,

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
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ACCOUNT NO. 23-0975

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January 6, 2005



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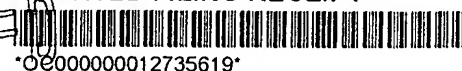
APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FILE FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/721,164	11/26/2003	1752	1974	2003-1698A	10	39	4

CONFIRMATION NO. 5528

000513
WENDEROTH, LIND & PONACK, L.L.P.
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WASHINGTON, DC 20006-1021

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UPDATED FILING RECEIPT



02000000012735619

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Date Mailed: 05/21/2004

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Applicant(s)

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Kazumasa Wakiya, Kanagawa, JAPAN;

Domestic Priority data as claimed by applicant

Foreign Applications

JAPAN 2002-343867 11/27/2002
JAPAN 2002-343868 11/27/2002
JAPAN 2002-343869 11/27/2002
JAPAN 2002-343870 11/27/2002

If Required, Foreign Filing License Granted: 04/24/2004

Projected Publication Date: 08/26/2004

Non-Publication Request: No

Early Publication Request: No

Title

see page 2.
→

~~Undercoating material for wiring, embedded material, and wiring formation method~~
Lower layer material for wiring, embedded material, and wiring formation

Preliminary Class

430

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